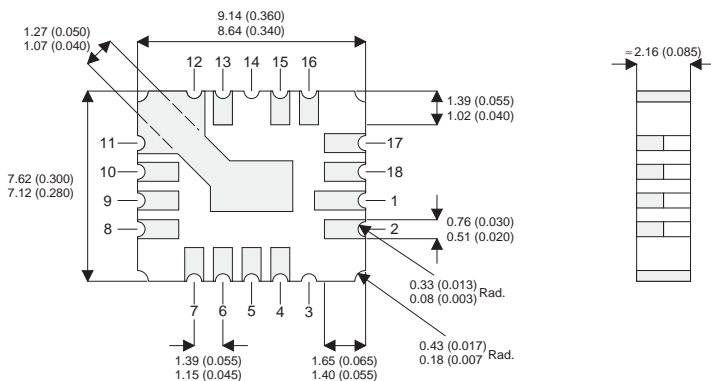


MECHANICAL DATA

Dimensions in mm (inches)



LCC4

GATE Pins 4,5
DRAIN Pins 1,2,15,16,17,18
SOURCE Pins 6,7,8,9,10,11,12,13

N-CHANNEL POWER MOSFET

V_{DSS} **100V**
 $I_{D(cont)}$ **3.5A**
 $R_{DS(on)}$ **0.6 Ω**

FEATURES

- SURFACE MOUNT
- SMALL FOOTPRINT
- HERMETICALLY SEALED
- DYNAMIC dv/dt RATING
- AVALANCHE ENERGY RATING
- SIMPLE DRIVE REQUIREMENTS
- LIGHTWEIGHT

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$ unless otherwise stated)

V_{GS}	Gate – Source Voltage	$\pm 20V$
I_D	Continuous Drain Current ($V_{GS} = 10V$, $T_{case} = 25^{\circ}C$)	3.5A
I_D	Continuous Drain Current ($V_{GS} = 10V$, $T_{case} = 100^{\circ}C$)	2.25A
I_{DM}	Pulsed Drain Current ¹	14A
P_D	Power Dissipation @ $T_{case} = 25^{\circ}C$	15W
	Linear Derating Factor	0.09W/ $^{\circ}C$
E_{AS}	Single Pulse Avalanche Energy ²	7.0mJ
dv/dt	Peak Diode Recovery ³	9.0V/ns
T_J , T_{stg}	Operating and Storage Temperature Range	-55 to +150 $^{\circ}C$
	Surface Temperature (for 5 sec).	300 $^{\circ}C$

Notes

- 1) Pulse Test: Pulse Width $\leq 300\mu s$, $\delta \leq 2\%$
- 2) @ $V_{DD} = 25V$, Peak $I_L = 3.1A$, Starting $T_J = 25^{\circ}C$
- 3) @ $I_{SD} \leq 3.1A$, $di/dt \leq 75A/\mu s$, $V_{DD} \leq BV_{DSS}$, $T_J \leq 150^{\circ}C$, Suggested $R_G = 7.5\Omega$

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ELECTRICAL CHARACTERISTICS (T_{case} = 25°C unless otherwise stated)

Parameter		Test Conditions		Min.	Typ.	Max.	Unit
STATIC ELECTRICAL RATINGS							
BV _{DSS}	Drain – Source Breakdown Voltage	V _{GS} = 0	I _D = 1mA	100			V
ΔBV _{DSS} ΔT _J	Temperature Coefficient of Breakdown Voltage	Reference to 25°C I _D = 1mA			0.12		V/°C
R _{DS(on)}	Static Drain – Source On–State Resistance ¹	V _{GS} = 10V	I _D = 2.25A			0.6	Ω
		V _{GS} = 10V	I _D = 3.5A			0.69	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS}	I _D = 250μA	2		4	V
g _{fs}	Forward Transconductance ¹	V _{DS} ≥ 15V	I _{DS} = 2.25A	0.8			S (Ω)
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0	V _{DS} = 0.8BV _{DSS}			25	μA
			T _J = 125°C			250	
I _{GSS}	Forward Gate – Source Leakage	V _{GS} = 20V				100	nA
I _{GSS}	Reverse Gate – Source Leakage	V _{GS} = –20V				–100	
DYNAMIC CHARACTERISTICS							
C _{iss}	Input Capacitance	V _{GS} = 0			190		pF
C _{oss}	Output Capacitance	V _{DS} = 25V			86		
C _{rss}	Reverse Transfer Capacitance	f = 1MHz			13		
Q _g	Total Gate Charge	V _{GS} = 10V				6.6	nC
Q _{gs}	Gate – Source Charge	I _D = 3.5A				1.7	
Q _{gd}	Gate – Drain (“Miller”) Charge	V _{DS} = 0.5BV _{DSS}				3.5	
t _{d(on)}	Turn–On Delay Time	V _{DD} = 50V				15	ns
t _r	Rise Time	I _D = 3.1A				25	
t _{d(off)}	Turn–Off Delay Time	R _G = 7.5Ω				25	
t _f	Fall Time					20	
SOURCE – DRAIN DIODE CHARACTERISTICS							
I _S	Continuous Source Current					3.5	A
I _{SM}	Pulse Source Current ²					14	
V _{SD}	Diode Forward Voltage ¹	I _S = 3.5A	T _J = 25°C			1.5	V
		V _{GS} = 0					
t _{rr}	Reverse Recovery Time	I _F = 3.5A	T _J = 25°C			180	ns
Q _{rr}	Reverse Recovery Charge ¹	d _i / d _t ≤ 100A/μs V _{DD} ≤ 50V				2.0	μC
t _{on}	Forward Turn–On Time			Negligible			
THERMAL CHARACTERISTICS							
R _{θJC}	Thermal Resistance Junction – Case					8.3	°C/W
R _{θJPC}	Thermal Resistance Junction – PC Board					27	

Notes

- 1) Pulse Test: Pulse Width ≤ 300ms, δ ≤ 2%
- 2) Repetitive Rating – Pulse width limited by maximum junction temperature.

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